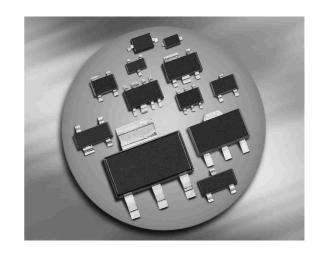


NPN Silicon Digital Transistor

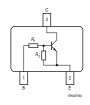
- Switching circuit, inverter, interface circuit, driver circuit
- Built in bias resistor (R_1 =47k Ω , R_2 =22k Ω)
- Pb-free (RoHS compliant) package
- Qualified according AEC Q101







BCR146



Туре	Marking)	Pin Configuration				Package	
BCR146	WLs	1=B	2=E	3=C	-	-	-	SOT23

Maximum Ratings

Parameter	Symbol	Value	Unit	
Collector-emitter voltage	$V_{\sf CEO}$	50	V	
Collector-base voltage	V_{CBO}	50		
Input forward voltage	$V_{i(fwd)}$	80		
Input reverse voltage	V _{i(rev)}	10		
Collector current	I _C	70	mA	
Total power dissipation-	P _{tot}	200	mW	
<i>T</i> _S ≤ 102°C				
Junction temperature	T _i	150	°C	
Storage temperature	T _{stq}	-65 150		

Thermal Resistance

Parameter	Symbol	Value	Unit
Junction - soldering point ¹⁾	R _{thJS}	≤ 240	K/W

1



Electrical Characteristics at $T_A = 25$ °C, unless otherwise specified

Parameter	Symbol		Values			
		min.	typ.	max.		
DC Characteristics				ì	,	
Collector-emitter breakdown voltage	V _{(BR)CEO}	50	-	-	V	
$I_{\rm C}$ = 100 $\mu {\rm A}$, $I_{\rm B}$ = 0						
Collector-base breakdown voltage	V _{(BR)CBO}	50	-	-		
$I_{\rm C} = 10 \ \mu {\rm A}, \ I_{\rm E} = 0$						
Collector-base cutoff current	I _{CBO}	-	-	100	nA	
$V_{\rm CB} = 40 \text{ V}, I_{\rm E} = 0$						
Emitter-base cutoff current	I _{EBO}	-	-	220	μA	
$V_{\rm EB}$ = 10 V, $I_{\rm C}$ = 0						
DC current gain ²⁾	h _{FE}	50	-	-	-	
$I_{\rm C}$ = 5 mA, $V_{\rm CE}$ = 5 V						
Collector-emitter saturation voltage ²⁾	V _{CEsat}	-	-	0.3	V	
$I_{\rm C}$ = 10 mA, $I_{\rm B}$ = 0.5 mA						
Input off voltage	V _{i(off)}	1.2	-	2.6		
$I_{\rm C}$ = 100 μ A, $V_{\rm CE}$ = 5 V						
Input on voltage	V _{i(on)}	1.5	-	4		
$I_{\rm C}$ = 2 mA, $V_{\rm CE}$ = 0.3 V						
Input resistor	R ₁	32	47	62	kΩ	
Resistor ratio	R_1/R_2	1.92	2.14	2.36	-	
AC Characteristics	·					
Transition frequency	f_{T}	-	150	-	MHz	
$I_{\rm C}$ = 10 mA, $V_{\rm CE}$ = 5 V, f = 100 MHz						
Collector-base capacitance	C _{cb}	-	3	-	pF	
$V_{CB} = 10 \text{ V}, f = 1 \text{ MHz}$						

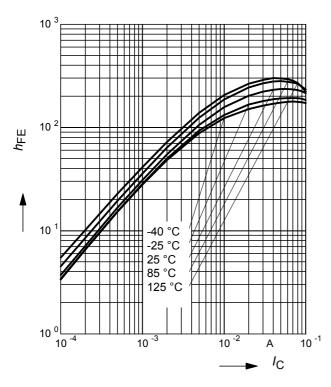
 $^{^{1}}$ For calculation of R_{thJA} please refer to Application Note AN077 (Thermal Resistance Calculation)

 $^{^2}$ Pulse test: t < 300 μ s; D < 2%



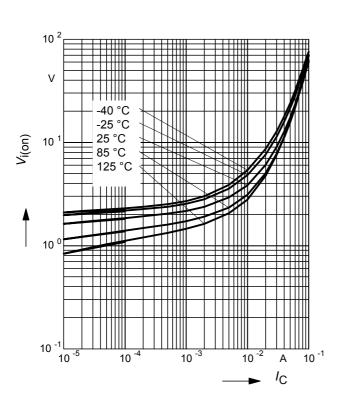
DC current gain $h_{FE} = f(I_C)$

 V_{CE} = 5V (common emitter configuration)



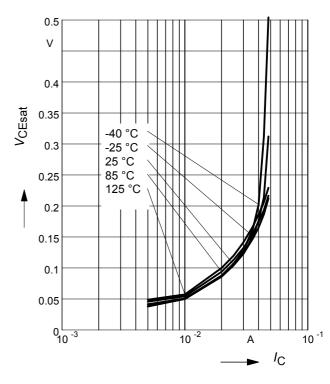
Input on Voltage $Vi_{(On)} = f(I_C)$

 $V_{CE} = 0.3V$ (common emitter configuration)



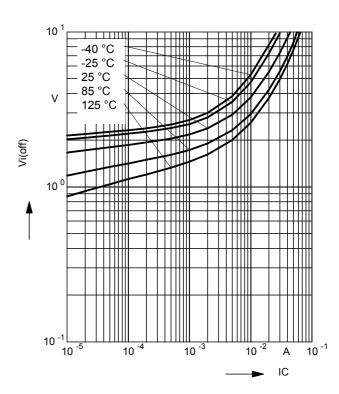
Collector-emitter saturation voltage

 $V_{CEsat} = f(I_{C}), I_{C}/I_{B} = 20$



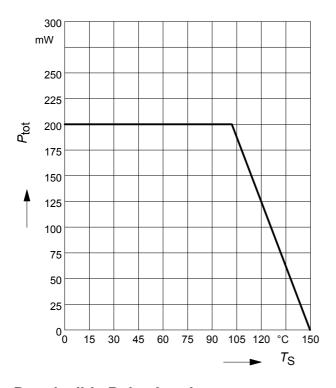
Input off voltage $V_{i(Off)} = f(I_C)$

 V_{CE} = 5V (common emitter configuration)

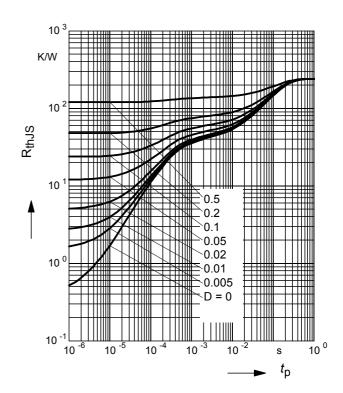




Total power dissipation $P_{tot} = f(T_S)$ BCR146



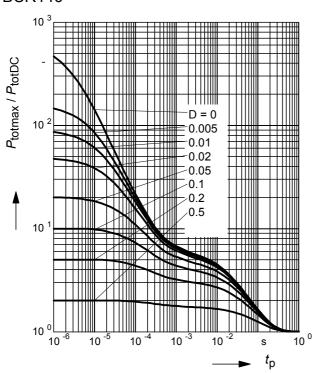
Permissible Pulse Load $R_{thJS} = f(t_p)$ BCR146



Permissible Pulse Load

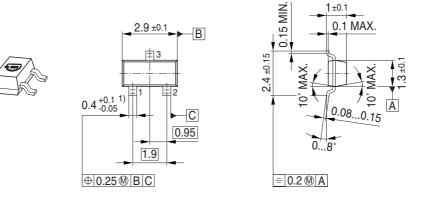
$$P_{\text{totmax}}/P_{\text{totDC}} = f(t_{\text{p}})$$

BCR146



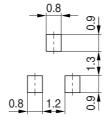


Package Outline



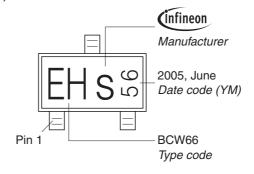
Foot Print





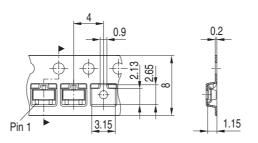
1) Lead width can be 0.6 max. in dambar area

Marking Layout (Example)



Standard Packing

Reel ø180 mm = 3.000 Pieces/Reel Reel ø330 mm = 10.000 Pieces/Reel



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6

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